

3D Nickel Foam (High PPI)

Catlog Number: BMBCC-0088

• Description

Ultra-high porosity nickel foam with 110 PPI (Pores Per Inch) for maximum active material loading in alkaline systems.

• Basic Information

Substrate Material: Pure Nickel

Purity (%): ≥ 99.8

Thickness (μm): 1500

Width (mm): 200

Areal Density (g/m^2): 350 - 450

Tensile Strength (MPa): ≥ 1.2

Elongation (%): ≥ 5.0

Surface Finish: Porous 3D

Surface Roughness (R_a , μm): 110 PPI

Electrical Resistivity ($\Omega\cdot\text{m}$): 7.0×10^{-8}

Thermal Conductivity ($\text{W}/\text{m}\cdot\text{K}$): 90

Melting Point ($^{\circ}\text{C}$): 1450

Oxidation Resistance (Temp/Time): 400°C / 45min

Coating Type: N/A

Coating Thickness (μm): N/A

Core ID (mm): N/A

Standard Length (m): 1 (Sheet)

Operating Voltage Range (V): 0.0 - 1.8

Application Compatibility: Ni-Cd / Ni-MH

Storage Requirements: General Dry

Form Factor: Sheet

Hydrophilic Properties: High Loading

Compliance / Grade: Industrial Grade

 For Research or Industrial Raw Materials, Not For Personal Medical Use!